

**Harvatek Surface Mount CHIP LEDs Data Sheet
B1931NB--20C007614U1930**

Official Product	HT Part No. B1931NB--20C007614U1930		
Tentative Product	*****	*****	
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DISCLAIMER

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HARVATEK's products are not authorized for use as critical components in life support devices or systems without the express written approval of the President of HARVATEK or HARVATEK INTERNATIONAL. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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Product Specifications

Item	Specification	Material	Quantity
Luminous Intensity(Iv)	NB:45.00-180.0 mcd @20mA/ T _s = 25°C;Tolerance: ± 10%		
Wavelength	NB:460.0-476.0 nm @20mA/ T _s = 25°C;Tolerance: ± 0.5nm		
Vf	NB: 2.7-3.9 V @20mA/ T _s = 25°C ;Tolerance: ± 0.05V		
Ir	< 10 μA @ V _R = 5 V		
Resin	Clear	Epoxy	
Carrier tape	EIA 481-1A specs	Conductive black tape	
Reel	EIA 481-1A specs	Conductive black	
Label	HT standard	Paper	
Packing bag	250x230mm	Aluminum laminated bag/ no-zipper	One reel per bag
Carton	HT standard	Paper	Non-specified

Others:

Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin combinations of Iv, λ_D and Vf. Each reel has a label identifying its specification; the immediate box consists of a product label as well.

Note :This is shipped test conditions

※Remarks: This product should be operated in forward bias. If a reverse voltage is continuously applied to the product, such operation can cause migration resulting in LED damage.

ATTENTION: Electrostatic Discharge (ESD) protection



The symbol to the left denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AlGaInP, GaN, or/and InGaN based chips are **STATIC SENSITIVE devices**. ESD precaution must be taken during design and assembly.

If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

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Label Specifications



■ Harvatek P/N:

B 193 1 NB-- 20C- 0076 14

Product	Package	Dice Q'ty	Color	Current	Series Number	Taping
PCB	1.6(L) x 0.8(W) x 0.4(H) mm	1:Single	NB:Blue	20mA	X001~XZZZ	1.Taping style 2. Q'ty

■ Lot No.:

1	2	3	4	5	6	7	8	9	10
E	1	A	1	A	2	2	L	1	2
Code 1 2		Code 3	Code 4	Code 5	Code 6	Code 7	Code 8	Code 9	Code 10
		Mfg. Year	Mfg. Month	Mfg. Date	Consecutive number		Special code		
Internal Tracing Code		2020-L		1:A	01~ZZ		000~ZZZ		
		2021-M		2:B					
		2022-P		3:C					
		2023-Q	1:Jan.	...					
		...	2:Feb.	...					
		2026-T	...	26:Z					
		2027-V	A:Oct.	27:7					
		...	B:Nov.	28:8					
		2030-Y	C:Dec.	29:9					
		2031-Z		30:3					
		...		31:4					

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Specifications Range**■ Luminous Intensity (Iv) Bin:**

Color	Bin Code	Spec. Range
NB	P	45.00-71.50 mcd
	Q	71.50-112.5 mcd
	R	112.5-180.0 mcd

Note: It maintains a tolerance of $\pm 10\%$ on Luminous Intensity

■ Wavelength Bin:

Color	Bin Code	Spec. Range
NB	A	460.0-464.0 nm
	B	464.0-468.0 nm
	C	468.0-472.0 nm
	D	472.0-476.0 nm

Note: It maintains a tolerance of $\pm 0.5\text{nm}$ on Wavelength Bin

■ Forward Voltage (Vf) Bin:

Color	Bin Code	Spec. Range
NB	G8	2.7-2.9 V
	H7	2.9-3.1 V
	H8	3.1-3.3 V
	J7	3.3-3.5 V
	J8	3.5-3.7 V
	K7	3.7-3.9 V

Note: It maintains a tolerance of $\pm 0.05\text{V}$ on forward voltage measurements

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Product Features

Electro-Optical Characteristics

(T_{Soldering} : 25 °C)

Series	Emitting Color	Material	V _F (V)		Wavelength λ(nm)			I _V (mcd)	Viewing Angle 2θ $\frac{1}{2}$
			typ	max	λ _D	λ _P	Δλ	Typical	
B1931NB--20	NB	InGaN	3.3	3.9	470	468	40	71.5	X=125 Y=135

Package Outline Dimension and Recommended Soldering Pattern for Reflow Soldering

(Unit:mm Tolerance: +/-0.1)

Outline Dim.	Suggest Soldering Pattern
Soldering terminals may shift in the x, y direction.	

Absolute Maximum Ratings

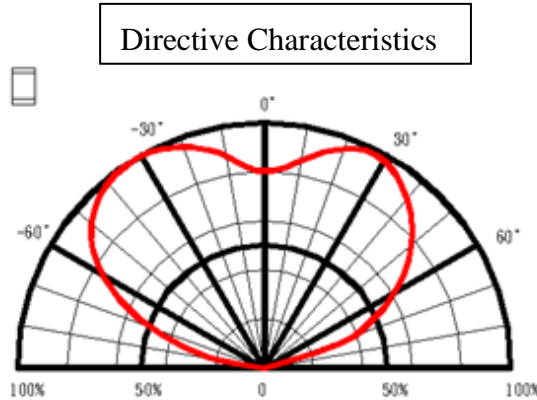
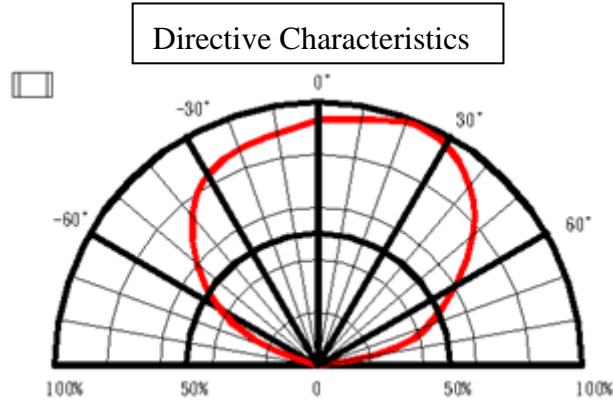
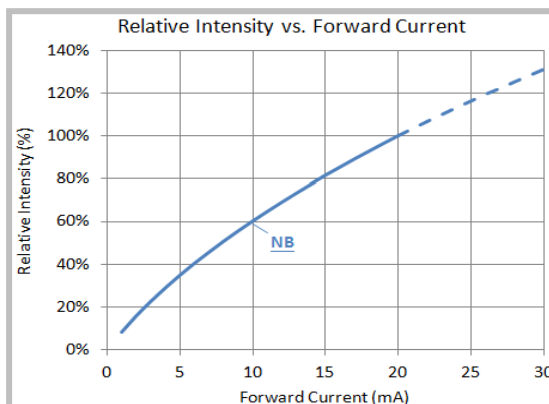
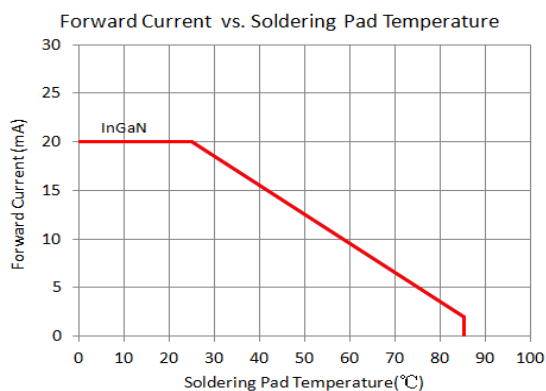
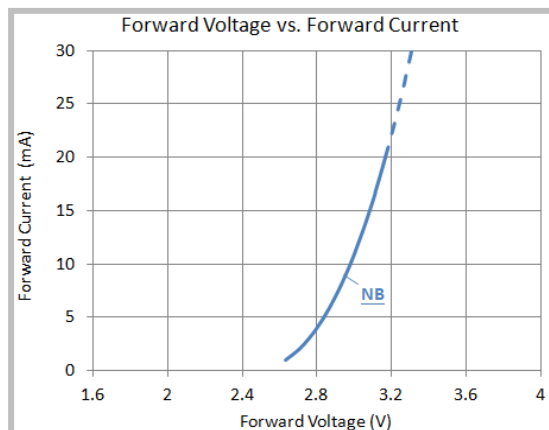
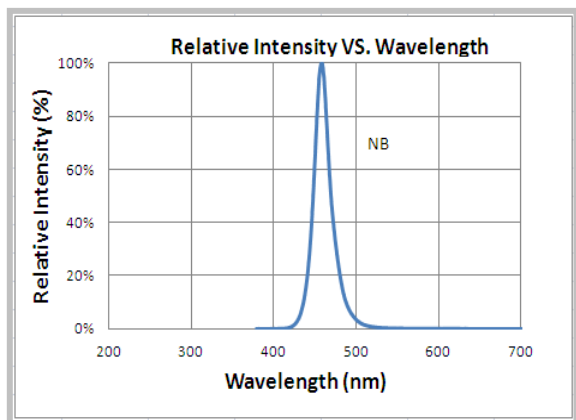
(T_{Soldering} 25 °C)

Series	P _D (mW)	I _F (mA)	I _{FP} (mA)*	T _{OP} (°C)	T _{ST} (°C)
Color	Power Dissipation	Forward Current	Pulse Forward Current	Operating Temperature	Storage Temperature
NB	78	20	80	-40~+85	-40~+100

*Condition for I_{FP} is pulse of 1/10 duty and 0.1msec width

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Characteristics of B1931NB



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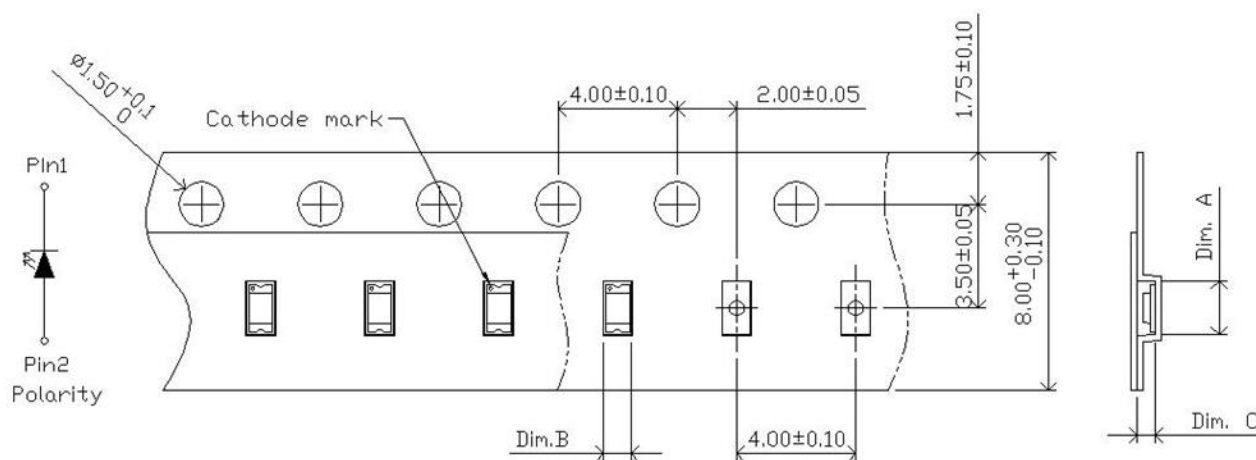
Precaution for Use

1. The chips should not be used directly in any type of fluid such as water, oil, organic solvent, etc.
2. When the LEDs are illuminating, the maximum ambient temperature should be first considered before operation.
3. LEDs must be stored in a clean environment. A sealed container with a nitrogen atmosphere is necessary if the storage period is over 3 months after shipping.
4. The LEDs must be used within 72hrs after unpacked. Unused products must be repacked in an anti-electrostatic package, folded to close any opening and then stored in a dry and cool space.
5. The appearance and specifications of the products may be modified for improvement without further notice.
6. The LEDs are sensitive to the static electricity and surge. It is strongly recommended to use a grounded wrist band and anti-electrostatic glove when handling the LEDs. If a voltage over the absolute maximum rating is applied to LEDs, it will damage LEDs. Damaged LEDs will show some abnormal characteristics such as remarkable increase of leak current, lower turn-on voltage and getting unlit at low current.

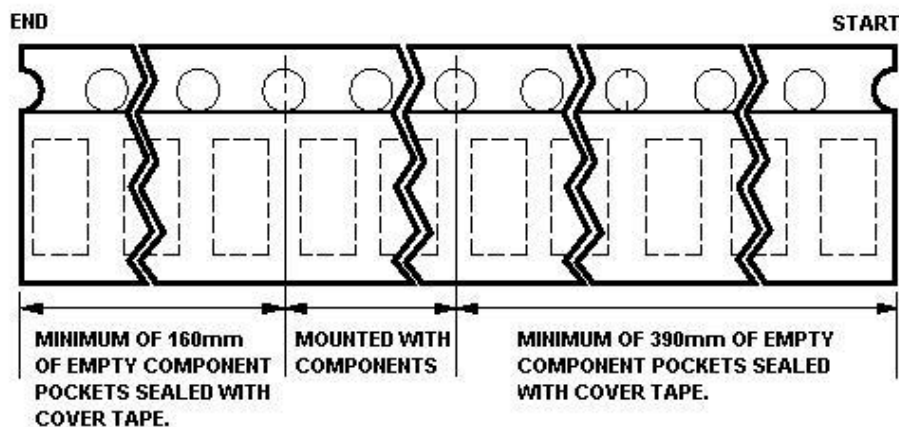
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Packaging

Tape Dimension

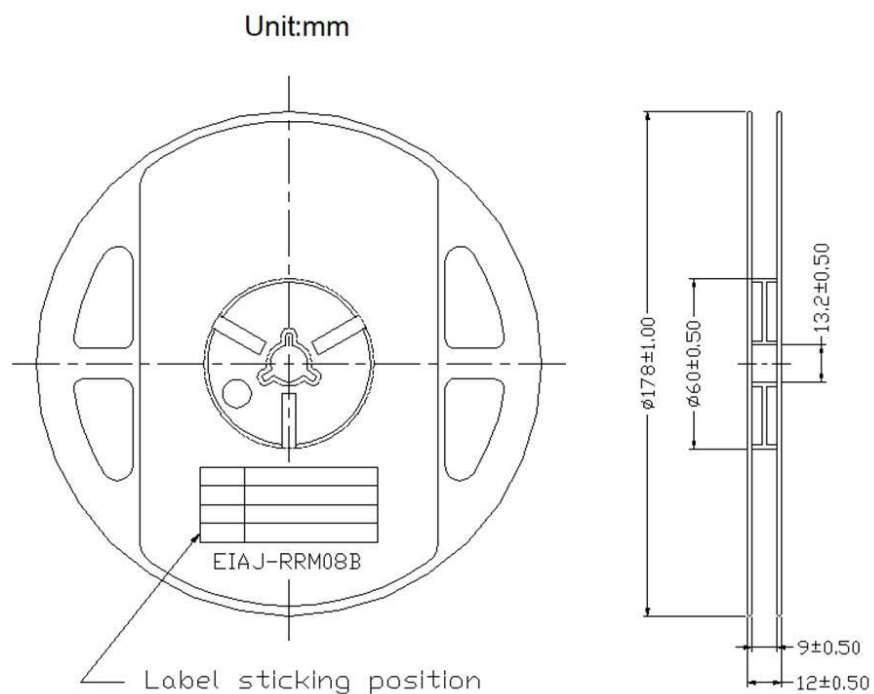


Dim. A	Dim. B	Dim. C	Q'ty/Reel
1.80±0.05	0.94±0.05	0.60±0.05	4K

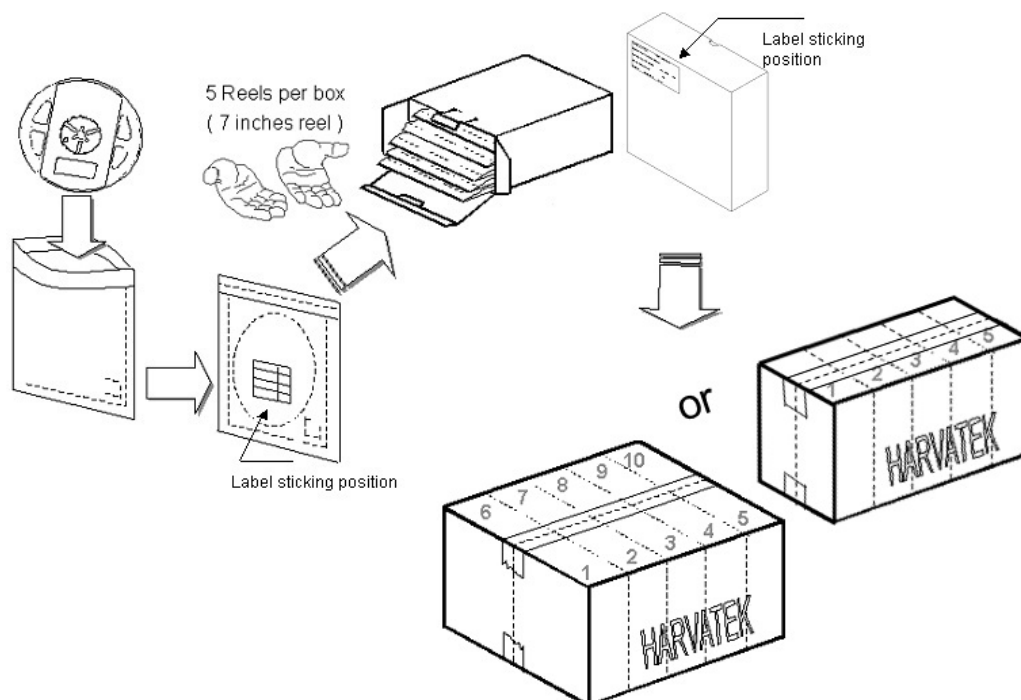


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Reel Dimension



Packing



5 or 10 boxes per carton is available depending on shipment quantity.

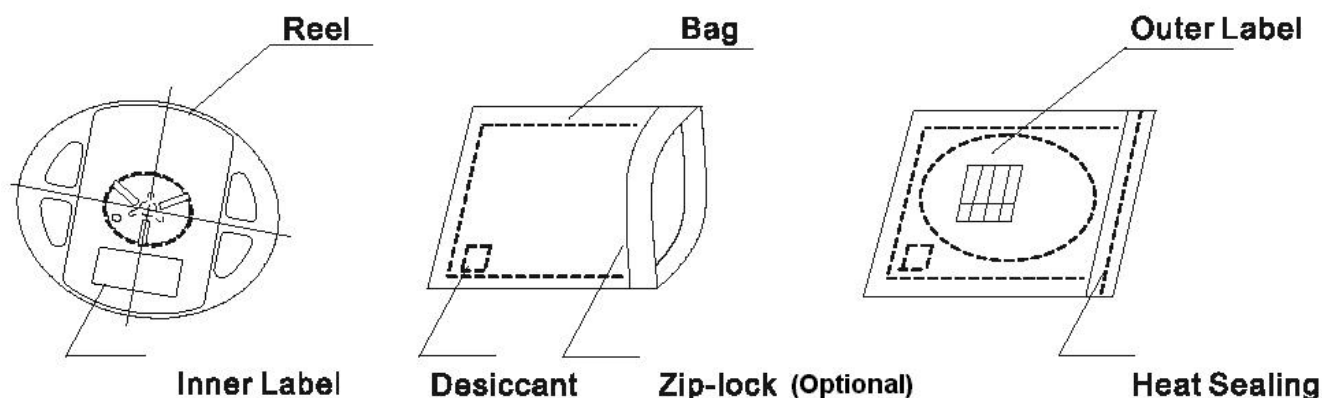
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Dry Pack

All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

A humidity indicator will be included in the moisture protected anti-static bag prior to shipment.

The packaging sequence is as follows:



Baking

Baking before soldering is recommended when the package has been unsealed for 72hrs.

The conditions are as followings:

1. $60\pm3^{\circ}\text{C} \times (12\sim 24\text{hrs})$ and $<5\%\text{RH}$, taped reel type.
2. $100\pm3^{\circ}\text{C} \times (45\text{min}\sim 1\text{hr})$, bulk type.
3. $130\pm3^{\circ}\text{C} \times (15\text{min}\sim 30\text{min})$, bulk type.

Precautions

1. Avoid exposure to moisture at all times during transportation or storage.
2. Anti-Static precaution must be taken when handling GaN, InGaN, and AlGaInP products.
3. It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage beyond the specified limit.
4. Avoid operation beyond the limits as specified by the absolute maximum ratings.
5. Avoid direct contact with the surface through which the LED emits light.
6. If possible, assemble the unit in a clean room or dust-free environment.

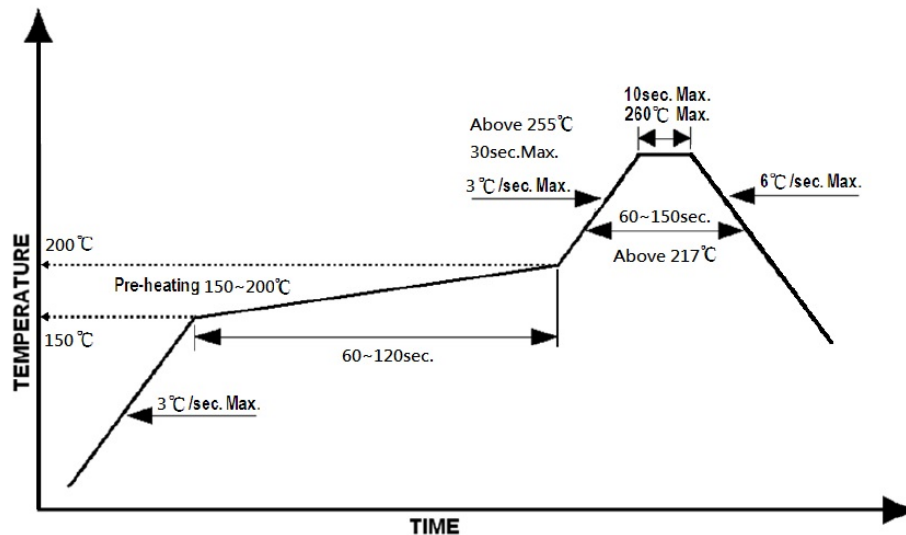
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Reflow Soldering

Recommend soldering paste specifications:

1. Operating temp.: Above 217°C ,60~150 sec.
2. Peak temp.:260°C Max.,10sec Max.
3. Reflow soldering should not be done more than two times.
4. Never attempt next process until the component is cooled down to room temperature after reflow.
5. The recommended reflow soldering profile (measured on the surface of the LED terminal) is as following:

Lead-free Solder Profile



Reworking

- Rework should be completed within 5 seconds under 260 °C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50°C x 30sec. or <30°C x 3min
- Ultrasonic cleaning: < 15W/ bath; bath volume ≤ 1liter
- Curing: 100 °C max, <3min

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Cautions of Pick and Place

- Avoid stress on the resin at elevated temperature.
- Avoid rubbing or scraping the resin by any object.
- Electric-static may cause damage to the component. Please ensure that the equipment is properly grounded. Use of an ionizer fan is recommended.

Revise History

Rev.	Descriptions	Date	Page
-	-	09/27/2022	-
1.0	Update to official version	10/04/2022	-

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